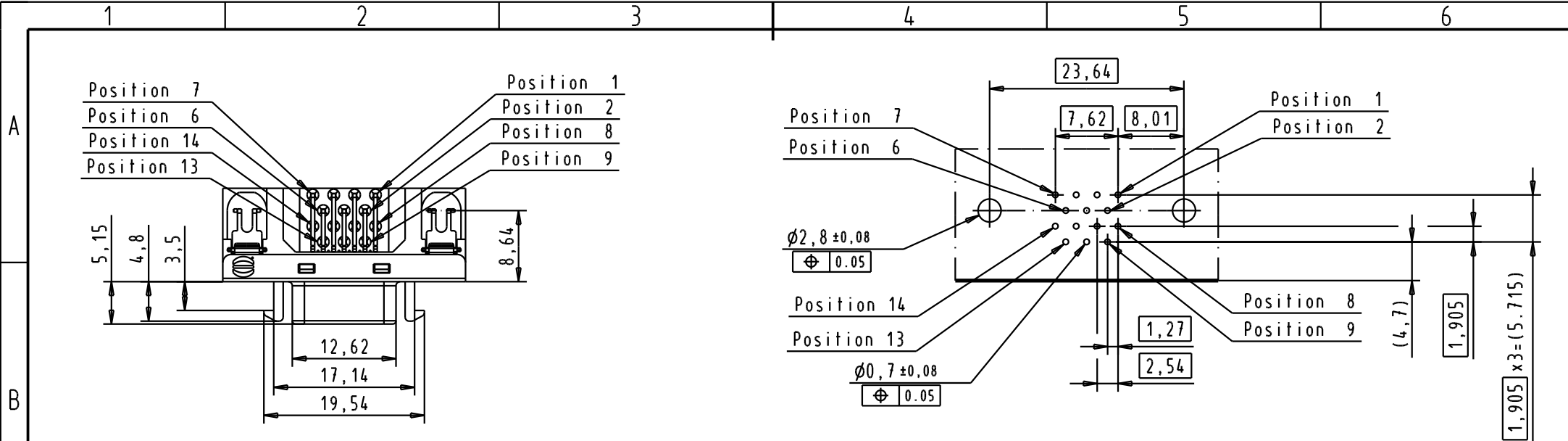
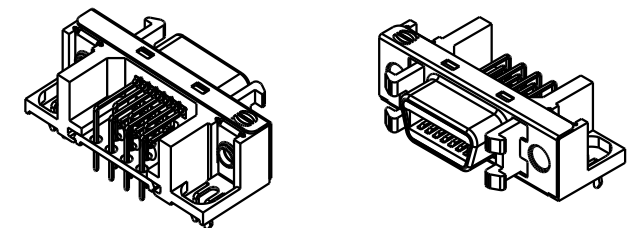
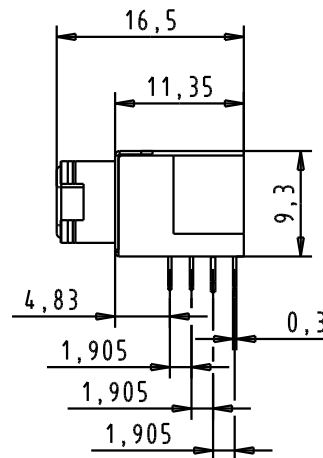
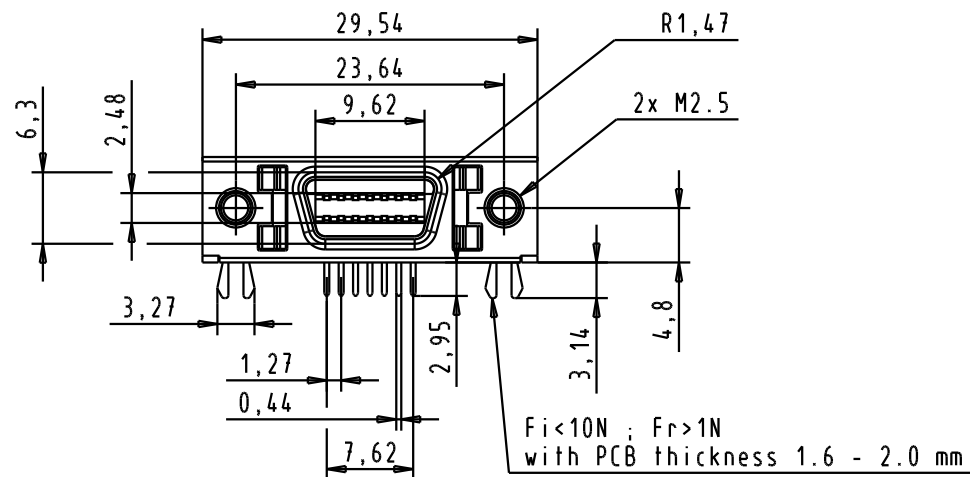




PCB Layout: component side



According to IEC 61076-3-100

1) see TB 60 11 014 5740
folio 2/2 for reel packaging

				Dat.	Name	 All Dim. in mm Orig. Size DIN A 4	har.mik® I/O bellow	 TB 60 11 014 5740 Sub.	Maßstab/ Scale 1.5:1 Blatt/ Page 1 / 2
			Detail.	11Jul2006	ED		14 poles female SMC with angled solder pins, boardlocks, fixed latches		
			Insp.						
			Stand.						
33811	18Oct2006	ED	HARTING EURL F-95972 Paris						
33795	07Aug2006	ED							
33781	12Jul2006	ED							
Mod.	Dat.	Name							